



## DEVTLB 3.0

Revision *DEVTLB\_3P0\_2022WW14\_R1p0\_v3*

Available in IPX: *soft\_enterprise\_ip.CPG\_EIP\_DEVTLB@6.DEVTLB\_3P0*

### What's New in this Release

This is a 1p0 v3 release for the DEVTLB 3.0 IP.

- Release Summary:
  - RTL Updates:
    - None
  - BugFixes:
    - [22014839654](#): LNL IPU/VPU RPD flow requirement on bees\_knees param override

### DEVTLB HAS

- Devtlb 3.0 HAS; Please request access:  
<https://ircs.intel.com/WebUI/Documents/Detail/60114>

### Supported Tools

This release is now Cheetah Compliant with the exceptions (if any) noted below.  
Please Refer Section 2.3 of the Integration Guide for Standalone IP Integrity Checks on the Cheetah Env.

### IPX Download Information

IP Library: [soft\\_enterprise\\_ip.CPG\\_EIP\\_DEVTLB@<ver>.DEVTLB\\_3P0](#)

- 'srvr10nm' group access is required to download the IP.
- <prefix> can set by IP Consumer. This command will create a branch in IPX from Mainline. The consumer can now download from this branch. Please avoid making multiple branches.

```
#Setup IPX in a new xterm shell:
% source /p/hdk/cad/ipxclient/prod/setup/ph1_ipxclient.setup
#Login with Unix Credentials
% pi login
% p4 login -a

#View Versions available
% pi ip ls soft\_enterprise\_ip.CPG\_EIP\_DEVTLB@.DEVTLB\_3P0 -a --model properties

#To Download, (6.DEVTLB_3P0 corresponds to DEVTLB_3P0_2022WW14_R1p0_v3)
% ipx ip branch -ip soft_enterprise_ip.CPG_EIP_DEVTLB@6.DEVTLB_3P0 -prefix <CUST>_
DEVTLB_3P0_2022WW14_R1p0_v3- -unixgroup srvr10nm -ipl-access srvr10nm:rwo
% pi ip load soft_enterprise_ip.CPG_EIP_DEVTLB@.<CUST>_ DEVTLB_3P0_2022WW14_R1p0_v3-
DEVTLB_3P0
```

### Reporting Issues

To report a bug with this IP or a tool issue, enter an HSD bug ticket [here](#).  
Family: "Data Streaming Accelerator, Release: "CPG Device TLB 2.0"

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